

U.S. Express Mail Label No. EL569074409US

PATENT APPLICATION
Docket No. 11675.114

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Kei-Yu Ko

Serial No.:

08/846,671

Filed:

April 30, 1997

For:

UNDOPED SILICON DIOXIDE AS ETCH
STOP
FOR SELECTIVE ETCH OF
DOPED SILICON DIOXIDE

Examiner:

George A. Goudreau



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RESPONSE TO ELECTION REQUIREMENT

The Honorable Commissioner of Patents
and Trademarks
Washington, D. C. 20231

Sir:

In response to the Office Action dated on February 12, 2001 (the "Office Action"),
the Applicant submits this Response.

IN THE CLAIMS:

Marked up Version of the Pending Claims Under 37 C.F.R. § 1.121(c)(1)(ii):

A clean version of the pending claims pursuant to 37 C.F.R. § 1.121(c)(3) is provided
hereinbelow after the following marked up version of the amended claims.

Please amend claim 33 as follows and in accordance with 37 C.F.R. § 1.121(c)(1)(ii), by

Response to Election Requirement
Serial No.08/846,671

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